

# СНР0232-РМ

## TrueTri>ngle<sup>™</sup> Preliminary Product Information July 2002 (1 of 8)

Features

- □ InGaP HBT Technology
- □ 6mm Square, 50 Ohm Power Module Package
- □ Single Positive Supply
- □ 35% Linear Power Added Efficiency
- □ +28.5 dBm Output Power (CDMA Mode)
- **29** dB Gain at Operating Output Power
- **On-Board Power Down Mode**
- **7 dB Gain Control via Vmode**

#### Applications

- **Cellular Multi-Mode Handsets**
- **Cellular Infrastructure**
- □ Wireless Local Loop Subscriber Units
- **CDMA Handsets**
- **CDMA2K 1X Handsets**

#### Description

The CHP0232-PM is a 50 ohm matched, single supply, linear power amplifier module intended for use in cellular handsets and wireless local loop subscriber units. The highly integrated amplifier meets the requirements of CDMA and CDMA2K 1X systems. It is a member of Celeritek's new *TrueTriangle*<sup>TM</sup> family of 3V power amplifier modules.

The CHP0232-PM is packaged in a low-cost, space efficient, 6mm square, matched module that provides excellent

#### **Absolute Maximum Ratings**

	0				
Parameter	Rating	Parameter	Rating	Parameter	Rating
Collector Voltage (+V <sub>cc</sub> )	+4.5 V*	Reference Voltage (V <sub>ref</sub> )	+3.1 V	Operating Temperature	-40°C to +85°C
Collector Current (I <sub>cc</sub> )	1.2 A	Power Dissipation	5 W	Storage Temperature	-65°C to +150°C
RF Input Power (High Mode	) 7 dBm	V Mode	+3.1 V	Soldering Temperature	260°C for 5 Sec.
RF Input Power (Low Mode)	13 dBm				

\* RF Off.

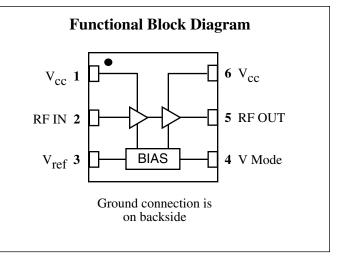
### **Recommended Operating Conditions**

Parameter	Тур	Units	Parameter	Тур	Units
Collector Voltage $(+V_{cc})$	3.2 to 4.1	Volts	Operating Temperature (PC Board)	-20 to +70	°C
Reference Voltage (V <sub>ref</sub> ) (Fixed and regulated)	+2.95 (±1.1%)	Volts	Mode Control Voltage (Vmode) High Low	3.0 (±5%) <1.2	V V

## **Application Information**

The CHP0232-PM is a two-stage amplifier that requires a single regulated positive supply along with the unregulated battery voltage for proper operation. Vref is a regulated 2.95 reference voltage for the bias control circuitry. It can also be used as a power down mode select. Vcc is an unregulated supply voltage directly from the battery. Vcc should be applied prior to Vref and before RF input power. Vmode is a control voltage selection between high and low gain mode. The CHP0232-PM can be operated over a range of supply voltages and bias points by adjustment of Vref. It is important that the maximum power dissipation of the package be observed at all times and that the maximum voltage across the device is not exceeded.

# 824 to 849 MHz 28.5 dBm, Cellular InGaP HBT Amplifier Module



electrical stability and low thermal resistance. The module operates from a fixed positive voltage and requires no external matching which significantly reduces space, cost and enhances ease of use. The device features 7 dB of gain control via an integrated attenuator.

The 6x6 mm package is self contained, incorporating 50 ohm input and output matching networks optimized for output power, linearity and efficiency.

Celeritek's InGaP HBT technology offers a thermally robust and reliable PAM (power amplifier module) solution.

### **Circuit Design Considerations**

**Biasing** The positive Vcc supply voltages are applied to pins 1 and 6. Most bypass decoupling is provided on-board. Vref is applied to pin 3.

The recommended DC bypass capacitance is shown in the schematic diagram on Page 8.

Inadequate bypass capacitance and inductance around the DC supply lines can compromise the adjacent channel power ratio (ACPR), reduce power gain and/or create oscillations.

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### **Electrical Characteristics**

Unless otherwise specified, the following specifications are guaranteed at room temperature with collector voltage  $(+V_{cc}) = 3.5 \text{ V}$ .

Parameter	Condition		Min	Тур	Max	Units
Frequency Range			824		849	MHz
Gain	Pout = 28.5 dBm	Vmode = High	28	29		dB
		Vmode = Low	21	22		dB
Gain Ripple*	824-849 MHz			1.0		dB
Gain Variation	Over supply voltage			2		dB/V
	Over temperature			0.03		dB/°C
Power Output	CDMA mode			+28.5		dBm
Harmonics	2nd @ Po = +28.5 dBm			-30		dBc
	3rd @ Po = +28.5 dBm			-30		dBc
Noise Power in Receive Band	30 kHz bandwidth			-90		dBm
Linearity (ACPR)	CDMA mode @ +28.5 dBm	Pout, 885 kHz offset		-52	-48	dBc/30kHz
	+28.5 dBm	Pout, 1.98 MHz offset		-60	-56	dBc/30 kHz
	CDMA2K 1X** @ +28.0 dBi	m Pout, 885 kHz offset		-52	-48	dBc/30 kHz
	CDMA2K 1X** @ +28.0 dBt		-61	-56	dBc/30 kHz	
Noise Figure					5.0	dB
Input Return Loss					-10	dB
Efficiency	Pout = $+28.5$ dBm - CDMA			38		%
Positive Supply Current (I <sub>cc</sub> )	Pout CDMA (12 dBm)			105	115	mA
	Pout CDMA (28.5 dBm)			535	560	mA
Quiescent Current (I <sub>q</sub> )	No RF			75		mA
V <sub>ref</sub> Supply Current (I <sub>ref</sub> )				2.0	5.0	mA
V <sub>ref</sub> Supply Voltage (V <sub>ref</sub> )	Fixed and regulated (1.2% tol	erance)		2.95		V
Vmode	Vmode = Low			0.1	0.4	V
Vmode	Vmode = High 2.85 3.0			3.15	V	
Imode	Vmode = High			400	800	μΑ
Leakage Current	Vref = 0V, Vcc = 3.5V		1		10	μΑ

\* Specifications guaranteed over the temperature range of -20°C to +70°C. \*\* Modulation HPSK in 1.2288 MHz, RC3 PAR = 4.7 @ 1% CCDF.

#### - Continued from Page 1 -

**Modulation** When biased as specified, the CHP0232-PM will achieve the required adjacent channel response for the digital system specified. Celeritek tests each product under digital modulation to ensure correlation to customer applications.

#### Thermal

1. The ground pad on the backside of the CHP0232-PM must be soldered to the ground plane.

2. All leads of the package must be soldered to the appropriate electrical connection.

#### **Physical Dimensions and PCB Footprint**

Contact the factory for detailed information and dimensions of HBT power module package and recommended printed circuit board footprint.







# СНР0232-РМ

#### **Preliminary Product Information - July 2002**



#### CDMA 1xRTT

In 1999 the International Telecommunications Union specified five different IMT-2000 standards colloquially known as Third Generation (3G) mobile phone services. Besides the WCDMA standard used by NTT Ducomo in Japan, the most important other 3G technology is Qualcomm's CDMA2000. CDMA2000 is available in several subsets, the first two of which are now in commercial operation.

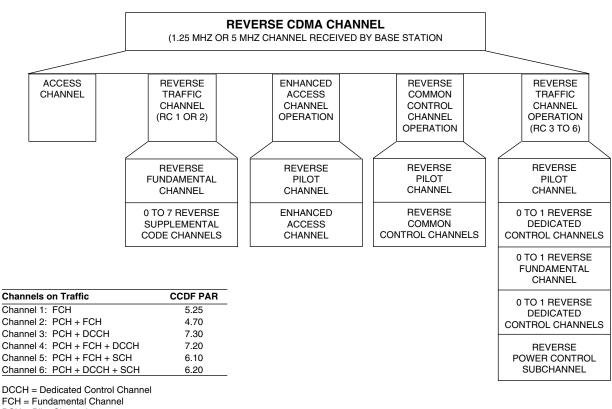
- CDMA2000 1xRTT roughly doubles a network voice capacity compound to the original CDMA One Technology. It also enables packet data transfers at up to 307 KB/s on a single 1.25 MHz carrier.
- CDMA2000 1xEV provides up to 2.4 MB/s packet data transfers on a single 1.25 MHz carrier in its current "data only" Phase 1 (1xEV-DO) version. Phase 2 (1xEV-DV) will provide up to 4.8 MB/s of integrated voice and data communications
- CDMA 3x will operate on newly licensed 5 MHz carriers and will potentially offer 3 times the number of voice and date channels, or higher data rates.

First launched in South Korea, operators in the United States and elsewhere are expected to migrate to CDMA2000 1xRTT in 2002.

The rapid progression from 2nd generation CDMAOne to CDMA2000 is an evolutionary migration. Service operators have the option to implement CDMA2000 1xRTT at their existing 1.25 MHz frequency bands. In this case the RF section of both the mobile phone and base station remains the same. But there are significant changes in the channel configuration which ultimately creates a need for additional linearity within the Power Amplifier Module. The major influence of the multi-channel configuration is a change in the Code Complementary Distribution Function (CCDF) commonly referred to as the peak-to-average ratio (PAR).

The handset re-use channel configuration is shown in Figure 1. Reverse Channel Configuration Details – Traffic Channels Defined. The parameters of each channel as detailed and interpreted from the CDMA2000 standard is detailed in Figure 2. Channel Configurations as Set Up in ESG Signal Source.

#### Figure 1. Reverse Channel Configuration Details – Traffic Channels Defined.



PCH = Pilot Channel



#### Figure 2. Channel Configurations as Set Up in ESG Signal Source

		Channel Voltage Gain				Channel Power Ratio			
Channels on Traffic		PCH	FCH	DCCH	SCH	PCH	FCH	DCCH	SCH
Ch 1: FCH	V Gain, dB		1.0				0		
	Bits per Sec.		9600				9600		
Ch 2: PCH + FCH	V Gain, dB	1.0	1.54			-5.278	-1.528		
	Bits per Sec.	On	9600			On	9600		
Ch 3: PCH + DCCH	V Gain, dB	1.0		1.54		-5.278		-1.528	
	Bits per Sec.	On		9600		On		9600	
Ch 4: PCH + FCH	V Gain, dB	1.0	0.512	1.54		-5.60	-11.48	-1.85	
	Bits per Sec.	On	1500	9600		On	1500	9600	
Ch 5: PCH + FCH + SCH	V Gain, dB	1.0	1.54		1.54	-7.59	-3.84		-3.84
	Bits per Sec.	On	9600		9600	On	9600		9600
Ch 6: PCH + DCCH + SCH	V Gain, dB	1.0		1.54	1.54	-7.59		-3.84	-3.84
	Bits per Sec.	On		9600	9600	On		9600	9600

DCCH = Dedicated Control Channel

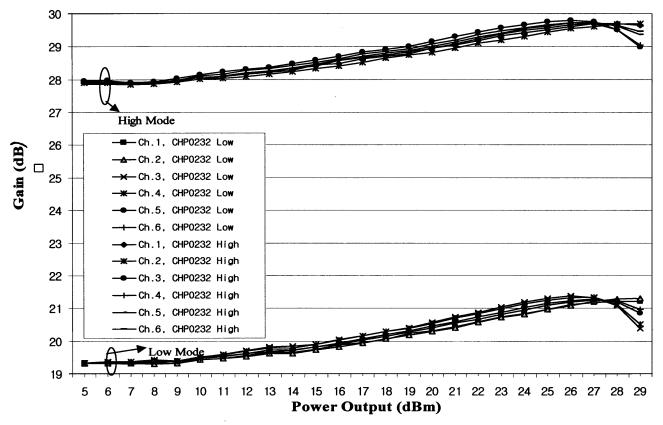
FCH = Fundamental Channel

PCH = Pilot Channel

SCH = Supplemental Code Channel

## **Typical Performance**

## **Gain vs Power Output**

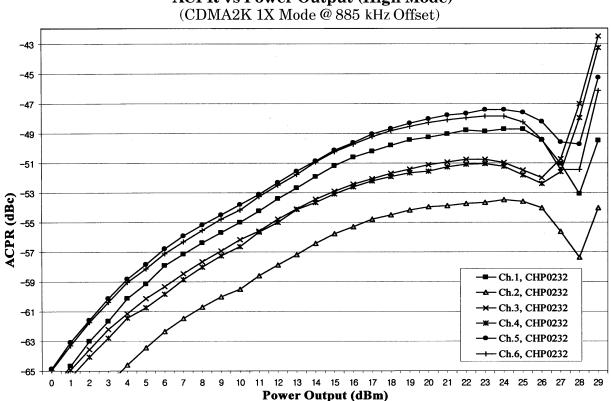




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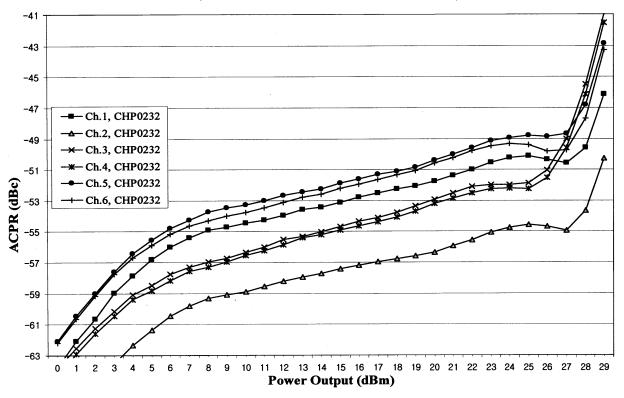
## **Preliminary Product Information - July 2002**



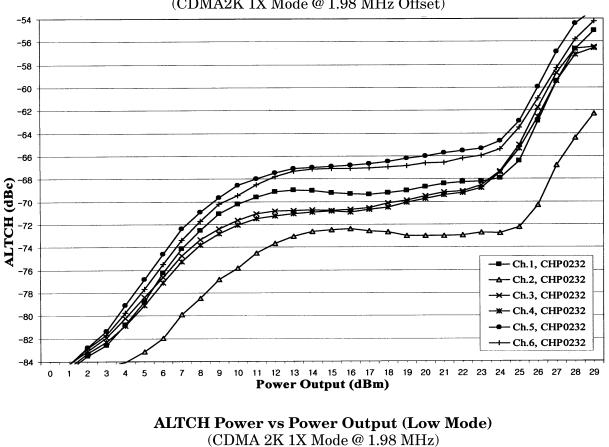


ACPR vs Power Output (High Mode)

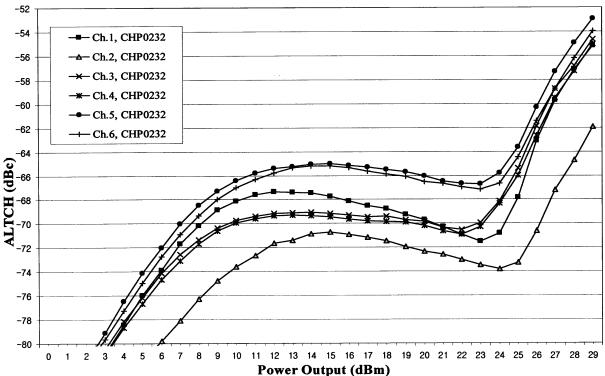
ACPR vs Power Output (Low Mode) (CDMA 2K 1X Mode @ 885 kHz Offset)







ALTCH Power vs Power Output (High Mode) (CDMA2K 1X Mode @ 1.98 MHz Offset)

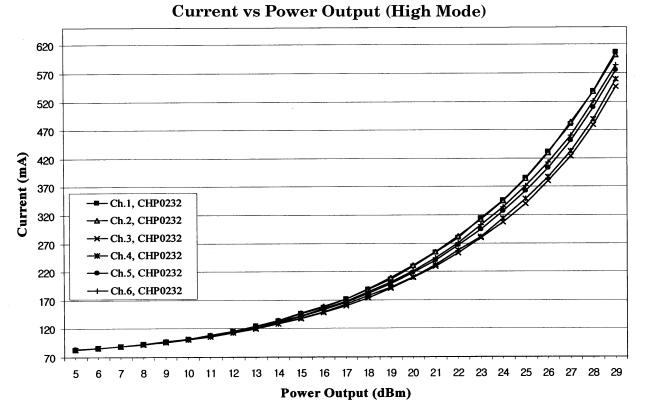




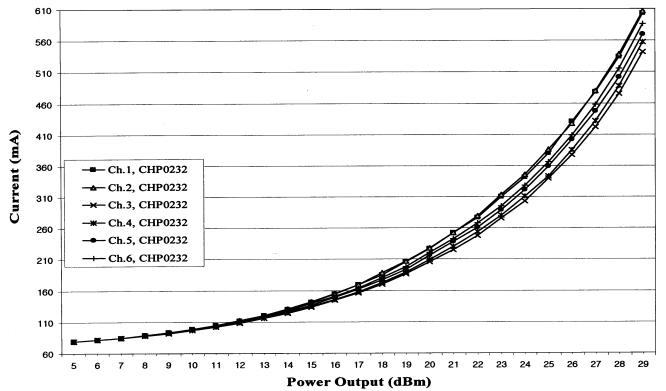


### **Preliminary Product Information - July 2002**

(7 of 8) TrueTri⊳nale<sup>™</sup>





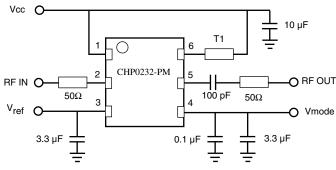


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### **Recommended Application Circuit**

Note: This schematic represents the topology of the application circuit recommended by Celeritek.



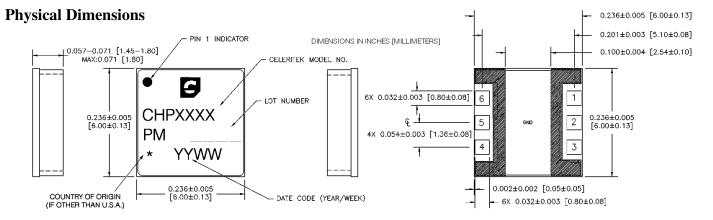
T1 line is important to ensure best bypassing. Optimum performance is achieved through an electrical length of min. 20° at 835 MHz.

**Evaluation Board Schematic** 

Board substrate: ER = 4.60Thickness = 0.031 in.

0.295 (7.50) 0.032 (0.80) 0.100 (2.55) MIN. X6 Ο Ο Ο Ο Ο Ο 0.240 0 Ο Ο (6.10)Ο Ο Ο 0.015 (0.38) DIA. Ο 0 0 VIA HOLE X21 Ο Ο С Ο Ο Ο 0.015 (0.40) RADIUS 0.054 (1.36) X4 X12 0.060 (1.50) MIN. ---> DIMENSIONS IN INCHES (mm)

DRAWING NOT TO SCALE



## **Ordering Information**

The CHP0232-PM is available in a surface mount 50 ohm matched module and devices are available in tube or tape and reel.

Part Number for Ordering	Package
CHP0232-PM-0000	PM6 CDMA surface mount power package in tube
СНР0232-РМ-000Т	PM6 CDMA surface mount power package in tape and reel
PB-CHP0232-PM	Evaluation Board with SMA connectors for CHP0232-PM

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**PCB Footprint** (Minimum Pad Dimensions)